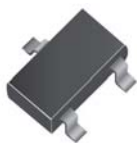
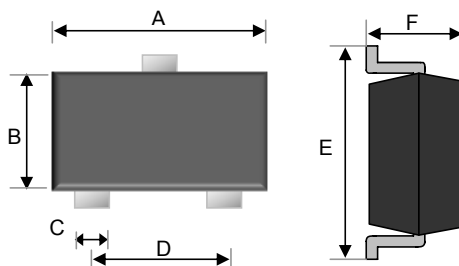


Small Signal Diode



SOT-23



Features

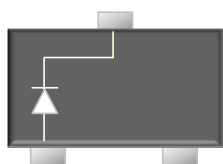
- ✧Fast switching speed
- ✧Surface device type mounting
- ✧Moisture sensitivity level 1
- ✧Matte Tin(Sn) lead finish with Nickel(Ni) underplate
- ✧Pb free version and RoHS compliant
- ✧Green compound (Halogen free) with suffix "G" on packing code and prefix "G" on date code

Mechanical Data

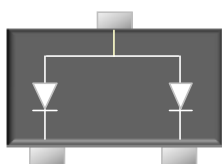
- ✧Case :SOT-23 small outline plastic package
- ✧Terminal: Matte tin plated, lead free., solderable per MIL-STD-202, Method 208 guaranteed
- ✧High temperature soldering guaranteed: 260°C/10s
- ✧Weight : 0.008gram (approximately)
- ✧Marking Code : HC.PZ.RA.PY.

Dimensions	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	2.80	3.00	0.110	0.118
B	1.20	1.40	0.047	0.055
C	0.30	0.50	0.012	0.020
D	1.80	2.00	0.071	0.079
E	2.25	2.55	0.089	0.100
F	0.90	1.20	0.035	0.043

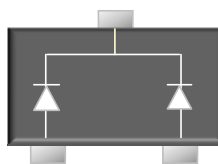
Pin Configuration



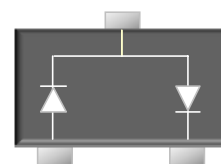
MMBD3004



MMBD3004CA



MMBD3004CC

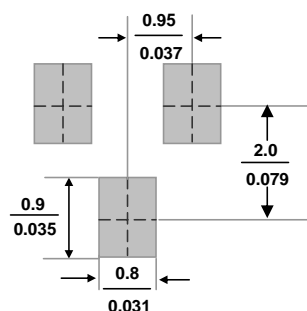


MMBD3004SE

Ordering Information

Part No.	Package	Packing Code	Packing	Marking
MMBD3004	SOT-23	RF	3K / 7" Reel	HC
MMBD3004CC	SOT-23	RF	3K / 7" Reel	PZ
MMBD3004CA	SOT-23	RF	3K / 7" Reel	RA
MMBD3004SE	SOT-23	RF	3K / 7" Reel	PY
MMBD3004	SOT-23	RFG	3K / 7" Reel	HC
MMBD3004CC	SOT-23	RFG	3K / 7" Reel	PZ
MMBD3004CA	SOT-23	RFG	3K / 7" Reel	RA
MMBD3004SE	SOT-23	RFG	3K / 7" Reel	PY

Suggested PAD Layout



Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Maximum Ratings

Type Number	Symbol	Value	Units
Power Dissipation	P _D	350	mW
Repetitive Peak Reverse Voltage	V _{RRM}	350	V
Repetitive Peak Forward Current	I _{FRM}	625	mA
Mean Forward Current	I _o	225	mA
Non-Repetitive Peak Forward Surge Current	I _{FSM}	4	A
Pulse width= 1μs Pulse width= 1s		1	
Thermal Resistance (Junction to Ambient)	R _{θJA}	357	°C/W
Junction and Storage Temperature Range	T _J , T _{STG}	-65 to + 150	°C

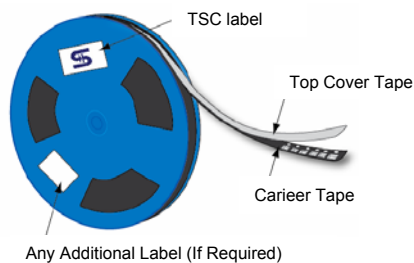
Note1. The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application.

Small Signal Diode

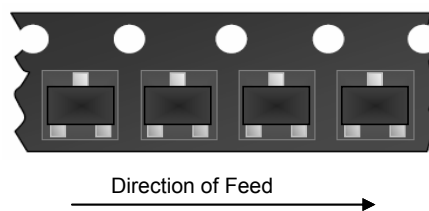
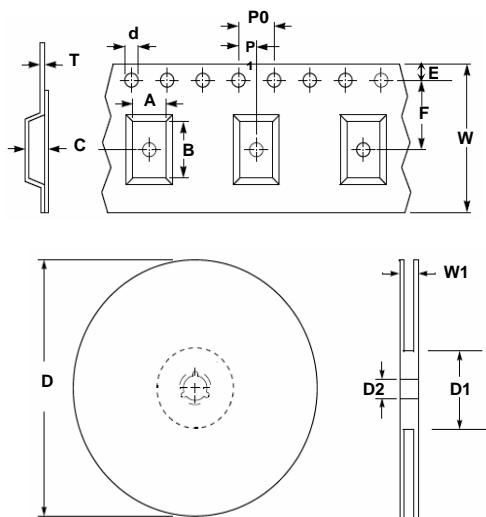
Electrical Characteristics

Type Number		Symbol	Min	Max	Units
Reverse Breakdown Voltage	$I_R = 100\mu A$	$V_{(BR)}$	350	-	V
Forward Voltage	$I_F = 100mA$	V_F	-	1.00	V
	$I_F = 200mA$		-	1.25	V
Reverse Leakage Current	$V_R = 240V$	I_R	-	0.1	μA
	$V_R = 240V, T_j = 150$		-	100.0	
Junction Capacitance	$V_R = 1V, f = 1.0MHz$	C_J	-	5	pF
Reverse Recovery Time	$I_F = I_R = 30mA, R_L = 100\Omega, I_{RR} = 0.1I_R$	T_{rr}	-	50.0	ns

Tape & Reel specification



Item	Symbol	Dimension(mm)
Carrier width	A	3.15 ± 0.10
Carrier length	B	2.77 ± 0.10
Carrier depth	C	1.22 ± 0.10
Sprocket hole	d	1.50 ± 0.10
Reel outside diameter	D	178 ± 1
Reel inner diameter	D1	55 Min
Feed hole width	D2	13.0 ± 0.20
Sprocket hole position	E	1.75 ± 0.10
Punch hole position	F	3.50 ± 0.05
Sprocket hole pitch	P0	4.00 ± 0.10
Embossment center	P1	2.00 ± 0.05
Overall tape thickness	T	0.229 ± 0.013
Tape width	W	8.10 ± 0.20
Reel width	W1	12.30 ± 0.20



Small Signal Diode

Rating and Sharacteristic Curves

FIG 1 Typical Forward Characteristics

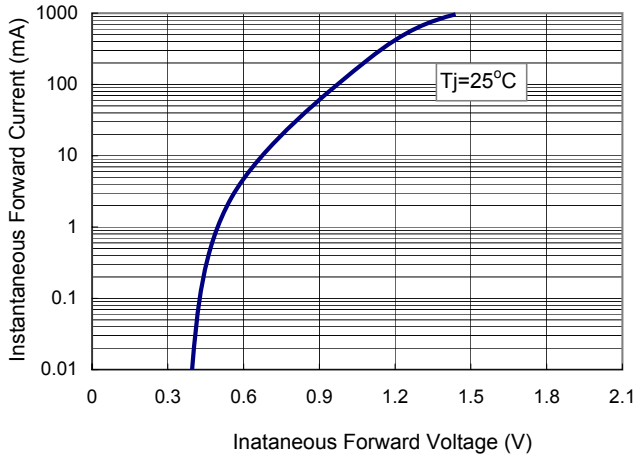


FIG 2 Typical Reverse Characteristics

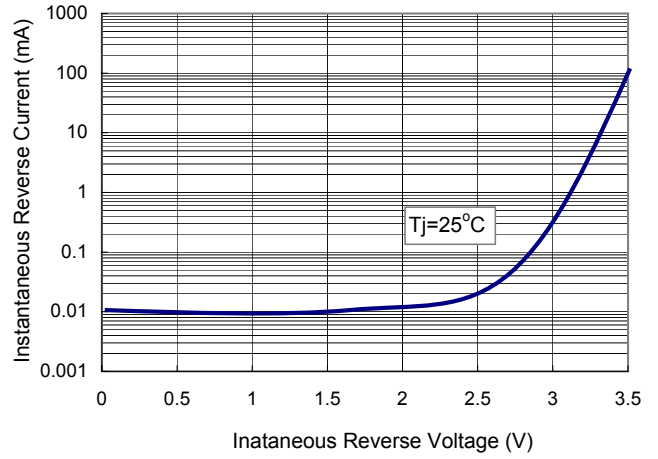


FIG 3 Admissible Power Dissipation Curve

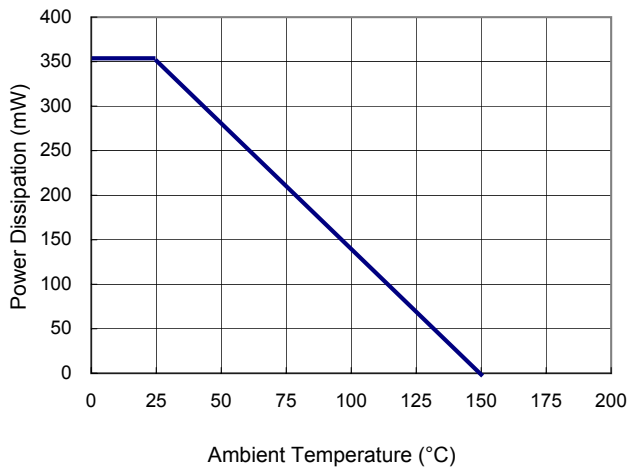


FIG4 Typical Capacitance vs Reverse Voltage

